# Grid Components Landscape: Challenges and Opportunities

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Next-Generation Grid Components R&D Program Planning Workshop

August 17, 2016 Pittsburgh, PA

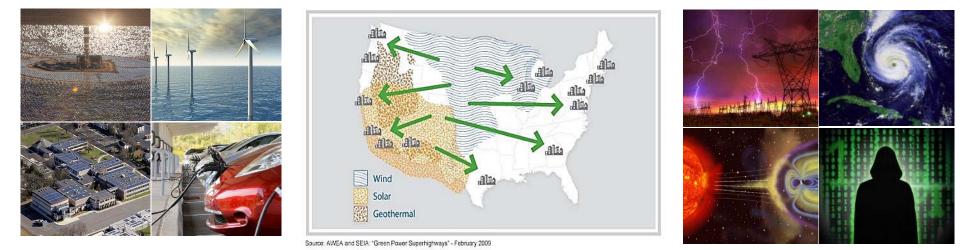


ORNL is managed by UT-Battelle for the US Department of Energy

# **Evolving energy mix and threats will affect how electricity is delivered**

#### Evolving energy mix

#### Potential threats



- How will these changes impact the transmission and distribution networks?
- What innovations must be made to what hardware to ensure reliable and affordable electricity?



## Five categories to consider

#### **Transformers**



Power transformers Distribution transformers Solid-state transformers Others

#### **Cables & Conductors**



Conductors Cables Connectors Others

#### **Flow Control**



HVDC Converters FACTS Voltage regulators Others

#### Sensors



#### **Protection Equipment**



Breakers Arresters FCLs Others



# High strength, low cost materials can increase the ampacity of OH lines

#### e.g. Deformation Processed Metal-Metal Composites –DMMC (Ames Lab):

Conductive-matrix nano-filament composites that is deformed under high strain can exhibit very high strength

Low cost, low density, highly conductive metals

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AI + 9%Ca

	ACSR	Al-20%Ca *
Density (g/cm <sup>3</sup> )	3.43	2.47
Strength (MPa)	304	660
DC cond 20°C ( $\mu\Omega m$ ) <sup>-1</sup>	38.1	36.2
Elastic modulus (GPa)	85	60
* Estimated		Ames Lab

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#### Issues:

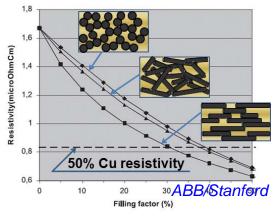
- Starting materials
- Processing/ Manufacturing
- Stability



# Low resistance materials can reduce losses, size and weight of components

#### Ultraconductive copper

- UCC (ICA, UCF, etc.)
  - Cu + CNTs (expansive)
  - Higher electrical conductivity, strength, thermal conductivity



#### **Issues:**

- Mechanisms
- Processing
- Process stability
  - Not repeatable
  - Not predictable

#### **Covetic Nanomaterials**

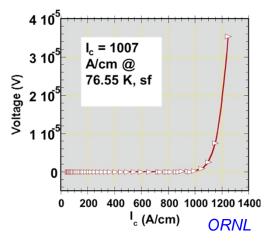
(DOE-AMO, NLs, U Md)

- Metal + Carbon
- Higher electrical conductivity, strength, thermal conductivity

#### %IACS Condition Туре 6061 47.4 Conv T6 47.8 T6 ground 3%C 56.1 T6 EDM 6061 67.3 As extruded EC-1350 61.8 Elect grade

#### Superconductors-

- HTS (companies)77K operation
  - Zero DC
     resistance



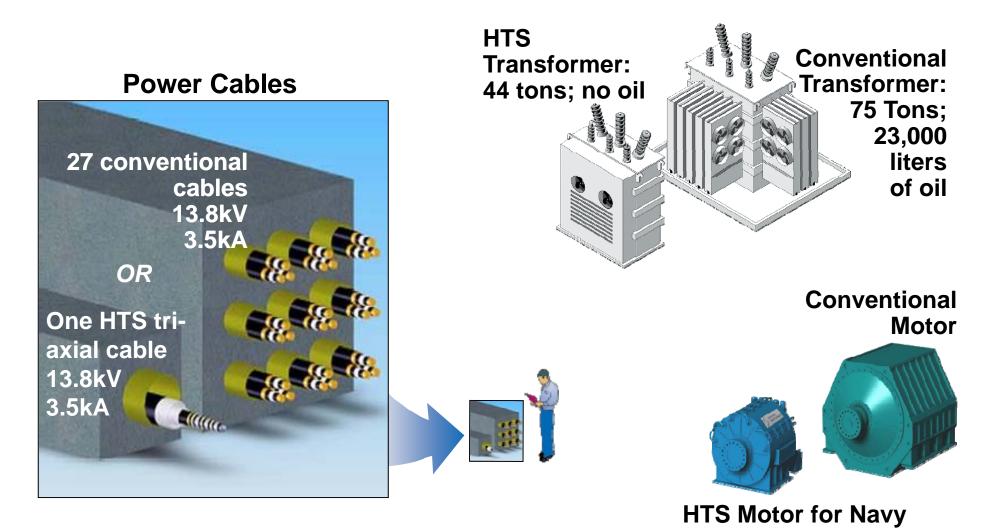


#### Issues:

- Mechanisms
- Processing
- Process stability?



## Impact on components: HTS example



#### Half the size and weight of conventional components



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## Novel soft magnetics can enhance the performance, reduce weight and size of grid components

Material	alloy composition	losses (20kHz, 200mT) [W/kg]	saturation Bsat [mT]	<b>magneto-</b> striction λ <sub>s</sub> [10 <sup>-6</sup> ]	permeability (50Hz) μ <sub>4</sub> - μ <sub>max</sub>	max. working temp. [°C]
grain oriented Silicon steel	Fe <sub>97</sub> Si <sub>3</sub>	> 1.000	2.000	9	2.000-35.000	appx.120
standard crystalline permalloy I	Ni45Fe55	> 150	1.550	25	12.000 - 80.000	130
standard crystalline permalloy II	Ni <sub>54</sub> Fe <sub>46</sub>	> 100	1.500	25	60.000-125.000	130
advanced Silicon steel	Fe <sub>93,5</sub> Si <sub>6,5</sub>	40	1.300	0,1	16.000	130
Fe- amorphous alloy	Fe <sub>76</sub> (Si,B) <sub>24</sub>	18	1.560	27	6.500 - 8.000	150
high performance ferrite	MnZn	17	500	21	1.500 - <b>15.000</b>	100/120
advanced crystalline permalloy	Ni <sub>80</sub> Fe <sub>20</sub>	> 15	800	1	150.000-300.000	130
Co-amorphous alloys a	C073(Si,B)27	5,0	550	< 0,2	100.000-150.000	90/120
Co-amorphous alloys b	C077(Si,B)23	5,5	820	< 0,2	2.000 - 4.500	120
Co-amorphous alloys c	Co80(Si,B)20	6,5	1.000	< 0,2	1.000 - 2.500	120
nanocrystalline alloys l	FeCuNbSiB	4,0	1.230	0,1	20.000-200.000	120/ <b>180</b>
nanocrystalline alloys II	FeCuNbSiB	4,5	1.350	2,3	20.000-200.000	120/ <b>180</b>
nanocrystalline alloys III	FeCuNbSiB	8,0	1.450	5,5	~ 100.000	120/ <b>180</b>

Issues:

 Manufacturing • Cost

Form factor



MAGNETEC GmbH

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## High voltage, high power Wide Bandgap semiconductor devices are emerging





\$70M DOE-AMO funds to accelerate the adoption of advanced semiconductor components made with SiC and GaN into a wide range of products and systems.

Property	Si	4H- SiC	GaN	Diamond
Bandgap (eV)	1.12	3.26	3.45	5.45
Breakdown Field (kV/cm)	300	2200	2000	10000
Thermal Cond (W/cm·K)	1.5	4.9	1.3	22
Dielectric const.	11.9	10.1	9	5.5
e Mobility (cm²/V·s)	1500	1000	1250	2200
Hole Mobility (cm <sup>2</sup> /V·s)	600	115	850	850

#### Commercial

SiC MOSFET 1.7 kV, 300 A Rds(on): 8 mΩ <u>SiC JFET</u> 1.2 kV, 38 A Rds(on): 45 mΩ <u>SiC Schottky</u> 1.2 kV, 160 A Rds(on): 10 mΩ

#### Research

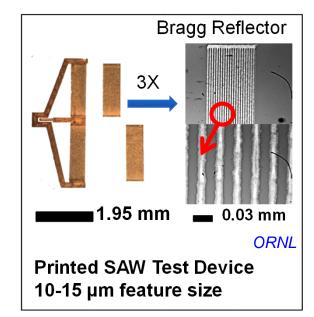
<u>SiC Schottky</u> 15 kV,250 mΩ-cm<sup>2</sup> <u>SiC MOSFET</u> 15 kV, 10A <u>SiC IGBT</u> 15 kV,20 A <u>SiC GTO</u> 8 kV,100 A-cm<sup>2</sup> <u>SiC p-GTO</u> 22 kV,20 A

# Sensors are essential for situation awareness, health monitoring

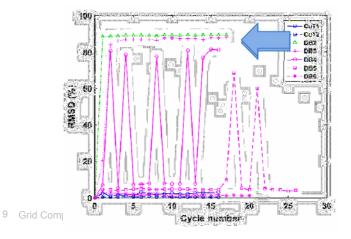
# e.g. Low cost, passive, wireless, direct-print sensors (ORNL)

- SAW passive, flexible platform, stick-n-peel
- Modalities
  - > Physical
  - Temperature
  - Pressure
  - Humidity
  - Strain / vibration
- > Electronic
  - Current flow CO<sub>2</sub>
  - Voltage
- Charge
- CH<sub>4</sub>
   VOCs

> Chemical



#### e.g. Structural integrity smart patch (ORNL)



- PZT-based sensor.
- Measure electromechanical impedance, which is affected by the mechanical integrity of the structure
- Root mean square deviation (RNSD) of conductance related to
  - □ Damage index
  - □ Fatigue, etc.

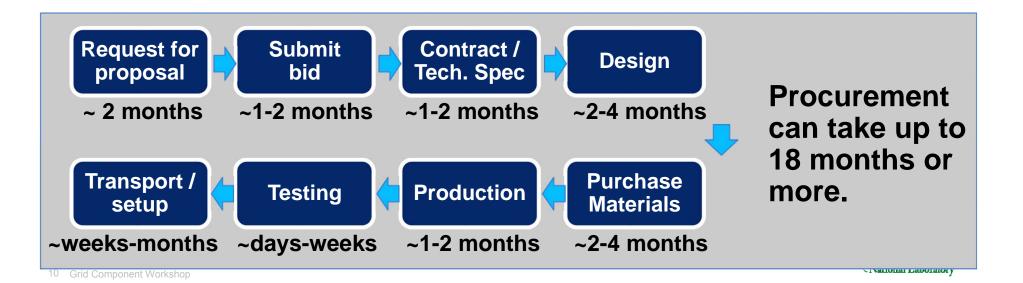


## Large power transformers: Expansive, large, heavy and takes long time to replace

Voltage Rating (Primary-Secondary)	Capacity MVA Rating	Approx. Price	Approx. Weight & Dimensions (tons / ft)			
Transmission transformer						
Three-Phase						
230-115 kV	300	\$ 2M	170, 21W x 27L x 25H			
345-138 kV	500	\$ 4M	335, 45W x 25L x 30H			
765-138 kV	750	\$ 7.5M	410, 56W x 40L x 45H			
Single-Phase						
765-345 kV	500	\$ 4.5M	235, 40W x 30L x 40H			
			LPTs2011 Estimates			



Large Power Transformers and the US Electric Grid: DOE-OE 2012 & 2014 update



# LPT Challenge: Fast replacements

#### Status:

#### Spare Programs:

STEP, SED, SpareConnect, Grid Assurance, DOE Transformer Reserve Study, private agreements...

#### Novel designs:

e.g. Siemen's GIC-safe power transformers



Siemens

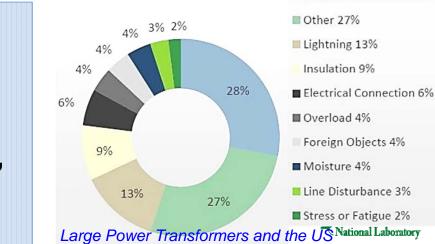
#### DHS Recovery Transformer (RecX):

- 3 single-phase 345-138kV modules, 600MVA
- Installed CenterPoint Energy substation: 106 hours
- Energized: March 17, 2012



Electrical Disturbances 28%

• 99% efficient, 14% fixed impedance, designed for 5-10 yrs



Electric Grid: DOE-OE 2014 update

- Flexible, adaptive, modular high efficiency designs with interchangeable parts
- Advanced materials: Soft magnetics, windings, insulation
- Approaches to extend LPT lifetime

## Solid State Transformer Challenge: High voltage, high efficiency, low cost, small footprint

- Combine ss devices and HF transformer to reduce system size and weight
- <u>Added functionalities</u>: DC bus and services such as voltage regulation, reactive power, flow control, limit fault current ...
- Issues: low efficiency, many devices (e.g. multi-level), expensive
- Prototype HF transformers showed nanocrystalline & amophous cores are possible candidates.
- ✓ UNIFLEX Smart Grid: 3.3 kV, 2 kHz amorphous core, 92% eff.
- ✓ GE Substation: 13.8 kV, 20 kHz nanocrystalline core, 98% eff.
- ✓ EPRI DC Charger: 2.4 kV, 20 kHz ferrite core, 96% eff.
- ✓ ABB Traction: 15 kV, 1.8 kHz nanocrystalline core 95% eff.

#### **Opportunities:**

- Novel designs & converter topologies
- WBG devices, packaging, thermal management, insulation
- HF magnetics & windings

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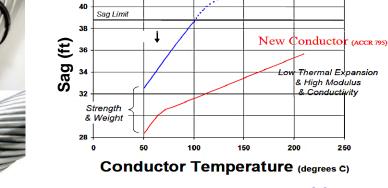
 $Grid \longleftrightarrow Power \\ Electronics \\ HF Transformer \\ Powler \\ Electronics \\ HF Transformer \\ HF$ 

## **Cables and Conductors Challenge: Deliver affordable power to load centers**

#### **Conductors** Status: **Reconductoring with** High-Temp-Low-Sag (HTLS)

- 2X ampacity
- Lower CTE, less sag ٠
- Higher strength to weight ٠
- Operation temp > 200°C ٠
- HTLS more expansive, but lower overall cost





3M-ACCR

200

ow Thermal Expansion & High Modulus

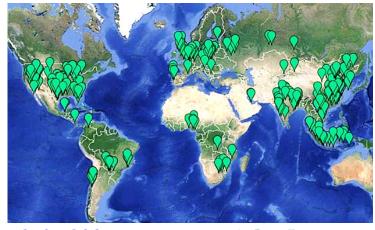
& Conductivity

250

Existing Conductor (ACSR 795)

#### **Opportunities:**

- Low cost HTLS utilizing advanced high strength / low resistance conducting materials
- Low cost coating for thermal management, anti-icing etc.



**CTC-ACCC** Projects



## **Cables:** Functionalities vs Cost

#### **DOE Superconducting Cables**

#### <u>Albany National</u> <u>Grid AC</u>



- 350 m, 34.5 kV, 800 A<sub>rms</sub>, 48 MVA
- 2G HTS wire section

# Columbus AEP AC

- 200 m, 13.2 kV, 3000 A<sub>rms</sub>, 69 MVA
- Triaxial concentric



- 600 m long, 138 kV, 2400 A<sub>rms</sub>, 574 MVA
- Transmission voltage

#### ORNL R&D DC

- 1 GW class
- Triax 2-layer
- Tested @ 9.5 kA, insulation 125 kV

#### Commercial:

e.g. ABB HVDC

 640 kV (±320 kV), 900 MW



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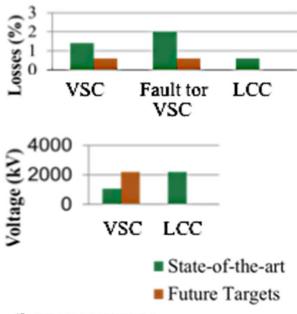
- Novel designs: reduce complexity, enhance reliability
- Insulations, thermal management
- HTS: Low AC loss, cryogenics



# HVDC Conversion Challenge: High voltage/power, low loss, small footprint

**HVDC:** long distance, underground, submarine, asynchronous, controlled power transfer, reduced right-o-way.

**LCC:** Thyristors Large blocks: 1000s MW High voltage: 1000 kV Many filters

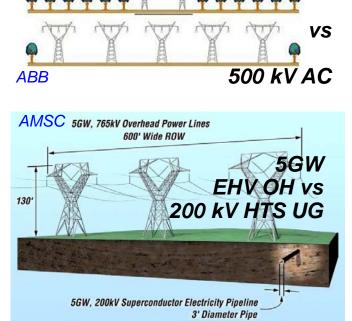


**VSC:** IGBTs Small blocks: 100s MW Lower voltage: 640 kV

MMC AAC CTL

### **Opportunities**:

- Novel topologies, hybrid LCC-VSC?
- WBG-based converters
- Insulation and thermal management



+500 kV DC

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## **FACTS :** Cost remains a major barrier

	1G FACTS	2G FACTS	3G FACTS	180
Typical Devices	SVC, TSC, TSR	TCSC, STAT- COM, SSSC	UPFC, IPFC	160 140 120
Function -alities	Reactive power compensation, voltage regulation,	Real/reactive power compensation, voltage/ current regulation, oscillation damping, limited dynamic and transient capability	Full power control, voltage/current control, oscillation damping, fault current limiting, full dynamic and transient capability	Fig. 3. Cost functions of the FACTS devices: SVC, TCSC and UPFC.
Control Type	Switching on/off or stepwise	Continuous	Continuous	: Upper limit: Total investment costs: Lower limit: Equipment costs Cai et al. U. Duisburg-Essen, DE

**D-FACTS:** Distributively installed, clamp on power lines.

Work collectively to adjust line impedance.

e.g. Smart wire - distributed series reactors.TVA Knox-Douglas line,7.5 miles, 100 DFACTS, 1 yr



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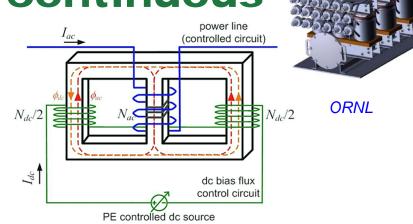
#### **Opportunities:**

- High power HV WBG devices
- Optimize DFACTS locations for efficiency and cost
   State Cost

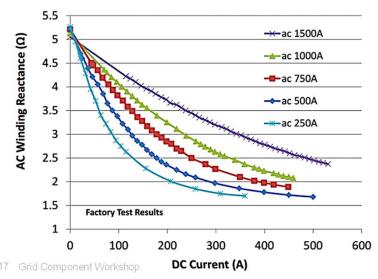
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## Continuous Variable Series Reactor may provide low cost continuous flow control

- CVSR based on magnetic amplifier
- Power electronics (control circuit) electrically decoupled from power line (controlled circuit)



- A small current in control circuit produces bias flux that changes the reactance of main circuit & controls much larger current in power line.
- 1-Φ 115 kV, 1.5 kA prototype factory tested



- Improve design for smaller, lighter, lower cost
- Additional capabilities of device with different control schemes



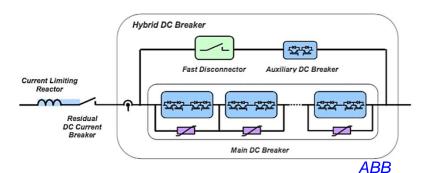
# **Protection Challenge:** Changing systems architecture, variable generations n& faults

# Emerging hybrid DC breakers are enablers for multi-terminal HVDC

Hybrid breaker would interrupt faults rapidly, possess better frequency switching ability, exhibit low losses and require less space.

e.g. ABB hybrid DC breaker:

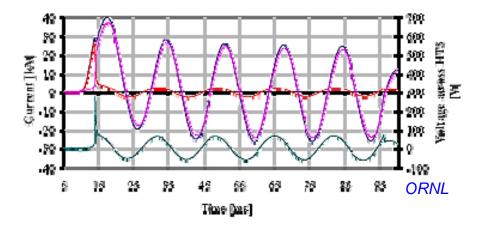
- A bypass branch auxiliary ss load commutation switch and ultra-fast mechanical disconnector & Main branch -- sections of ss DC breakers with arrester banks
- Normal operation: Current flows through bypass
- Fault:
  - 1) Auxiliary DC breaker commutates current to main breaker and disconnector opens.
  - 2) Main DC breakers break the current.
  - 5 ms opening time
- Alston ultra-fast "mechatronic" circuit breaker (UFMCB) Siemens DC commutation breaker (Metallic Return Transfer Breaker)





- Novel designs and topologies
- High power HV WBG
- Low loss compact SS CB

# Fault Current Limiters are designed to limit faults rapidly and then automatically reset

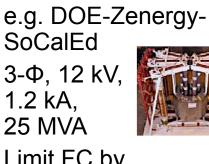


# Many superconducting FCL projects at distribution level:

#### <u>Resistive</u> e.g. AMPACITY –

#### Essen DE $3-\Phi$ , 10 kV, 2.3 kA, 40 MVA Limit 50 kA peak $\rightarrow$ <13 kA in 100 ms

#### Induction



Limit FC by 20%

# Opportunities:

- Innovative hybrid FCLs
- Transmission level SFCL
- High power/voltage WBG
   for SSFCL

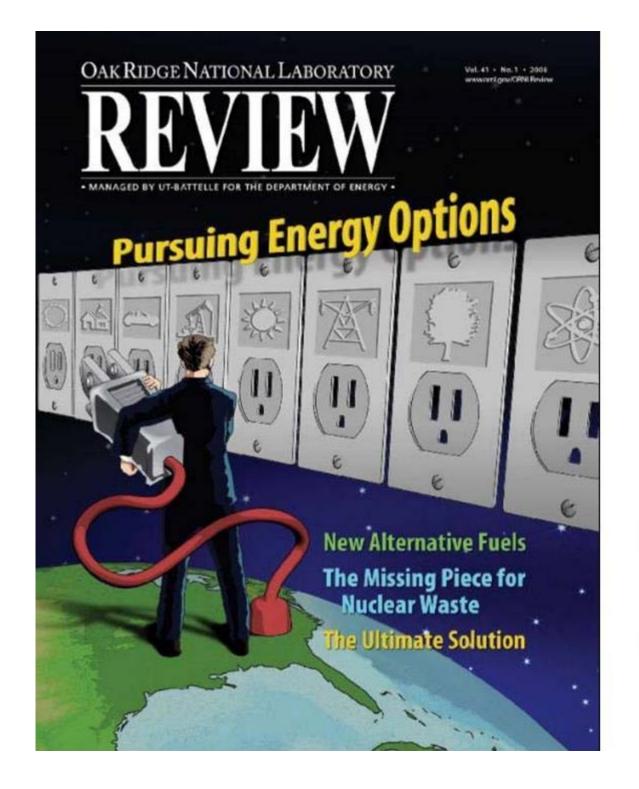


# Limited experience with solid-state FCL:

e.g. DOE-Silicon Power-EPRI

1-Φ, 15.5 kV, 1.2 kA, 25 MVA Limit 55 kA peak → 21.6 kA







#### **Contact information:**

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